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### 1. SCOPE

Х

1.1 <u>Scope</u>. This drawing documents the general requirements of a high performance low distortion differential radio frequency (RF) / intermediate frequency (IF) amplifier microcircuit, with an operating temperature range of -55°C to +105°C.

1.2 <u>Vendor Item Drawing Administrative Control Number</u>. The manufacturer's PIN is the item of identification. The vendor item drawing establishes an administrative control number for identifying the item on the engineering documentation:

	<u>V62/16616</u>	- <u>01</u>	¥	Ę	
	Drawing number	Device type (See 1.2.1)	Case ou (See 1.:	tline Lead finish 2.2) (See 1.2.3)	
1.2.1	Device type(s).				
	Device type	Generic		Circuit function	
	01	AD8351-E	P	Low distortion differential RF / IF	- amplifier
1.2.2	Case outline(s). The case of	outline(s) are as specified h	nerein.		
	Outline letter	Number of pins	JEDEC PUB 95	Package sty	le

MO-220-WEED-4

Lead frame quad chip scale package

1.2.3 Lead finishes. The lead finishes are as specified below or other lead finishes as provided by the device manufacturer:

Finish designator	Material
А	Hot solder dip
В	Tin-lead plate
С	Gold plate
D	Palladium
E	Gold flash palladium
Z	Other

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## 1.3 Absolute maximum ratings. 1/

Supply voltage (VPOS)	6 V
PWUP voltage	VPOS
Internal power dissipation (PD)	320 mW
Maximum junction temperature (TJ)	125°C
Storage temperature range (TSTG)	-65°C to +150°C
Lead temperature range (soldering, 60 seconds)	+300°C
Thermal resistance, junction to ambient (0JA)	79.1°C/W

## 1.4 Recommended operating conditions. 2/

Supply voltage (VPOS)	5 V
Operating free-air temperature range (TA)	-55°C to +105°C

## 2. APPLICABLE DOCUMENTS

JEDEC Solid State Technology Association

JEDEC PUB 95 - Registered and Standard Outlines for Semiconductor Devices

(Copies of these documents are available online at <u>http://www.jedec.org</u> or from JEDEC – Solid State Technology Association, 3103 North 10th Street, Suite 240–S, Arlington, VA 22201-2107).

#### 3. REQUIREMENTS

3.1 <u>Marking</u>. Parts shall be permanently and legibly marked with the manufacturer's part number as shown in 6.3 herein and as follows:

- A. Manufacturer's name, CAGE code, or logo
- B. Pin 1 identifier
- C. ESDS identification (optional)

3.2 <u>Unit container</u>. The unit container shall be marked with the manufacturer's part number and with items A and C (if applicable) above.

3.3 <u>Electrical characteristics</u>. The maximum and recommended operating conditions and electrical performance characteristics are as specified in 1.3, 1.4, and table I herein.

3.4 Design, construction, and physical dimension. The design, construction, and physical dimensions are as specified herein.

3.5 Diagrams.

3.5.1 <u>Case outline</u>. The case outline shall be as shown in 1.2.2 and figure 1.

3.5.2 Terminal connections. The terminal connections shall be as shown in figure 2.

<u>1</u>/ Stresses beyond those listed under "absolute maximum rating" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

2/ Use of this product beyond the manufacturers design rules or stated parameters is done at the user's risk. The manufacturer and/or distributor maintain no responsibility or liability for product used beyond the stated limits.

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Test	Symbol	Conditions <u>2</u> /	Temperature,	Device type	Lin	nits	Unit
					Min	Max	
Dynamic performance.			•	•	•	•	•
-3 dB bandwidth		AV = 6 dB, VOUT $\leq$ 1.0 Vp-p	25°C	01	3000	typical	MHz
		AV = 12 dB, VOUT $\leq$ 1.0 Vp-p			2200	typical	
		AV = 18 dB, VOUT $\leq$ 1.0 Vp-p			600 t	ypical	
Bandwidth for 0.1 dB flatness		$\begin{array}{l} 0 \mbox{ dB} \leq A v \leq 20 \mbox{ dB}, \\ V_{OUT} \leq 1.0 \mbox{ Vp-p} \end{array}$	25°C	01	200 t	ypical	MHz
Bandwidth for 0.2 dB flatness		$\begin{array}{l} 0 \mbox{ dB} \leq A v \leq 20 \mbox{ dB}, \\ V_{OUT} \leq 1.0 \mbox{ Vp-p} \end{array}$	25°C	01	400 t	ypical	MHz
Gain accuracy		Using 1% resistor for RG, 0 dB $\leq$ AV $\leq$ 20 dB	25°C	01	±1 ty	vpical	dB
Gain supply sensitivity		VS ±5%	25°C	01	0.08 t	ypical	dB/V
Gain temperature sensitivity			-55°C to +105°C	01	3.9 ty	/pical	mdB/ °C
Slew rate		$R_L = 1 k\Omega$ , $V_{OUT} = 2 V step$	25°C	01	13000	typical	V/µs
		RL = 150 Ω, VS = 2 V step			7500	typical	
Settling time		1 V step to 1%	25°C	01	< 3 ty	/pical	ns
Overdrive recovery time		$\label{eq:VIN} \begin{array}{l} VIN = 4 \; V \; \text{to} \; 0 \; V \; \text{step}, \\ VOUT \leq \pm 10 \; mV \end{array}$	25°C	01	< 2 ty	/pical	ns
Reverse isolation (S12)			25°C	01	-67 t <u>y</u>	ypical	dB
Input/output characteristic	cs.						
Input common mode voltage adjustment range			25°C	01	1.2 to 3.	8 typical	V
Maximum output voltage swing		1 dB compressed	25°C	01	4.75 t	ypical	Vp-p
Output common mode offset			25°C	01	40 ty	pical	mV

# TABLE I. Electrical performance characteristics. 1/

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Test	Symbol	Conditions <u>2</u> /	Temperature, TA	Device type	Lin	nits	Unit
					Min	Max	
Input/output characteristics – continued.							
Output common mode drift			-55°C to +105°C	01	0.24 t	ypical	mV/ °C
Output differential offset voltage			25°C	01	20 ty	rpical	mV
Output differential offset drift			-55°C to +105°C	01	0.13 t	ypical	mV/ °C
Input bias current			25°C	01	±15 t	ypical	μA
Input resistance 3/			25°C	01	5 typical		kΩ
Input capacitance 3/			25°C	01	0.8 typical		pF
Common mode rejection ratio	CMRR		25°C	01	43 ty	rpical	dB
Output resistance 3/			25°C	01	150 t	ypical	Ω
Output capacitance 3/			25°C	01	0.8 ty	/pical	pF
Power interface.							
Supply voltage			25°C	01	3	5.5	V
PWUP threshold			25°C	01	1.3 ty	/pical	V
PWUP input bias		PWUP at 5 V	25°C	01	100 typical		μA
current		PWUP at 0 V			25 ty	pical	
Quiescent current			-55°C to +105°C	01	28 ty	pical	mA
						35	

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Test	Symbol	Conditions <u>2</u> /	nditions <u>2</u> / Temperature, Device Limits I TA type		Unit		
					Min	Max	
Noise/distortion at 10 MH	lz.			•			•
Second/third <u>4</u> /		RL = 1 kΩ, Vout = 2 Vp-p	25°C	01	-95/-93 typical		dBc
		RL = 150 Ω, Vout = 2 Vp-p			-80/-69	typical	
Third order intermodulation distortion	IMD	R <sub>L</sub> = 1 kΩ, f1 = 9.5 MHz, f2 = 10.5 MHz, VOUT = 2 Vp-p composite	25°C	01	-90 t	/pical	dBc
		RL = 150 Ω, f1 = 9.5 MHz, f2 = 10.5 MHz, VOUT = 2 Vp-p composite			-70 t	/pical	
Output third order intercept		f1 = 9.5 MHz, f2 = 10.5 MHz	25°C	01	33 ty	rpical	dBm
Noise spectral density (referred to input, RTI)			25°C	01	2.65 1	ypical	nV/ √Hz
1 dB compression point			25°C	01	13.5 1	ypical	dBm
Noise/distortion at 70 MH	lz						
Second/third <u>4</u> / harmonic distortion		RL = 1 kΩ, VOUT = 2 Vp-p	25°C	01	-79/-81	typical	dBc
		RL = 150 Ω, VOUT = 2 Vp-p			-65/-66	typical	
Third order intermodulation distortion	IMD	RL = 1 kΩ, f1 = 69.5 MHz, f2 = 70.5 MHz, VOUT = 2 Vp-p composite	25°C	01	-85 t	/pical	dBc
		RL = 150 Ω, f1 = 69.5 MHz, f2 = 70.5 MHz, VOUT = 2 Vp-p composite			-69 t	/pical	
Output third order intercept		f1 = 69.5 MHz, f2 = 70.5 MHz	25°C	01	31 ty	rpical	dBm
Noise spectral density (referred to input, RTI)			25°C	01	2.70 1	ypical	nV/ √Hz
1 dB compression point			25°C	01	13.31	ypical	dBm

DLA LAND AND MARITIME	SIZE	CODE IDENT NO.	DWG NO. <b>V62/16616</b>	
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Test	Symbol	Conditions <u>2</u> /	Temperature,	Device type	Limits		Unit
					Min	Max	
Noise/distortion at 140 M	Hz						
Second/third <u>4</u> /		RL = 1 kΩ, VOUT = 2 Vp-p	25°C	01	-69/-69 typical		dBc
		RL = 150 Ω, VOUT = 2 Vp-p			-54/-53 typical		
Third order intermodulation distortion	IMD	R <sub>L</sub> = 1 kΩ, f1 = 139.5 MHz, f2 = 140.5 MHz, VOUT = 2 Vp-p composite	25°C	01	01 -79 typical		dBc
		RL = 150 Ω, f1 = 139.5 MHz, f2 = 140.5 MHz, VOUT = 2 Vp-p composite			-67 t	/pical	
Output third order intercept		f1 = 139.5 MHz, f2 = 140.5 MHz	25°C	01	29 ty	rpical	dBm
Noise spectral density (referred to input, RTI)			25°C	01	2.75 1	ypical	nV/ √Hz
1 dB compression point			25°C	01	13 ty	pical	dBm
Noise/distortion at 240 M	Hz						
Second/third <u>4</u> / harmonic distortion		RL = 1 kΩ, VOUT = 2 Vp-p	25°C	01	-60/-66	typical	dBc
		RL = 150 Ω, VOUT = 2 Vp-p			-46/-50	typical	
Third order intermodulation distortion	IMD	RL = 1 kΩ, f1 = 239.5 MHz, f2 = 240.5 MHz, VOUT = 2 Vp-p composite	25°C	01	-76 t	/pical	dBc
		RL = 150 Ω, f1 = 239.5 MHz, f2 = 240.5 MHz, VOUT = 2 Vp-p composite			-62 t	/pical	
Output third order intercept		f1 = 239.5 MHz, f2 = 240.5 MHz	25°C	01	27 ty	rpical	dBm
Noise spectral density (referred to input, RTI)			25°C	01	2.901	ypical	nV/ √Hz
1 dB compression point			25°C	01	13 ty	pical	dBm

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- 1/ Testing and other quality control techniques are used to the extent deemed necessary to assure product performance over the specified temperature range. Product may not necessarily be tested across the full temperature range and all parameters may not necessarily be tested. In the absence of specific parametric testing, product performance is assured by characterization and/or design.
- <u>2</u>/ Unless otherwise specified, VS = 5 V, RL = 150  $\Omega$ , RG = 110  $\Omega$ , AV = 10 dB, f = 70 MHz, TA = +25°C and some parameters may be specified differentially. The gain (AV) can be set to any value between 0 dB and 26 dB.
- 3/ Values are specified differentially.
- 4/ See the manufacturer's datasheet for information about single ended to differential operation.

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FIGURE 1. Case outline.

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Case X

Case X – continued.

	Dimensions					
Symbol		Inches			Millimeters	
	Minimum	Medium	Maximum	Minimum	Medium	Max
А	.0275	.0295	.0314	0.70	0.75	0.80
A1	.0031 COPLANARITY	.0007 NOM	.0019	0.08 COPLANARITY	0.02 NOM	0.05
A2		.0079 REF			0.203 REF	
b	.0070	.0098	.0118	0.18	0.25	0.30
D/E	.1141	.1181	.1220	2.90	3.00	3.10
D1/E1	.0629	.0669 SQ	.0708	1.60	1.70 SQ	1.80
е		.0196 BSC		0.50 BSC		
L	.0118	.0157	.0177	0.30	0.40	0.45
L1	.0078			0.20		

NOTES:

- Controlling dimensions are millimeter, inch dimensions are given for reference only.
  For proper connection of the exposed pad, refer to the pin configuration and function descriptions section of the manufacturer's datasheet.
  Falls within reference to JEDEC MO-220-WEED-4.

FIGURE 1. Case outline - Continued.

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Device type	01		
Case outline		Х	
Terminal number	Terminal symbol	Description	
1	RGP1	Gain resistor input 1.	
2	INHI	Balanced differential input, high. Biased to midsupply, typically ac-coupled.	
3	INLO	Balanced differential input, low. Biased to midsupply, typically ac-coupled.	
4	RGP2	Gain resistor input 2.	
5	NC	No connect. Do not connect to this pin.	
6	NC	No connect. Do not connect to this pin.	
7	NC	No connect. Do not connect to this pin.	
8	NC	No connect. Do not connect to this pin.	
9	COMM	Device common. Connect this pin to a low impedance ground.	
10	OPLO	Balanced differential output, low. Biased to VOCM, typically ac-coupled.	
11	OPHI	Balanced differential output, high. Biased to VOCM, typically ac-coupled.	
12	VPOS	Positive supply voltage. 3 V to 5.5 V.	
13	VOCM	Input/output common mode voltage. The voltage applied to this pin sets the common mode voltage at both the input and output. This pin is typically decoupled to ground with 0.1 $\mu$ F capacitor.	
14	NC	No connect. Do not connect to this pin.	
15	NC	No connect. Do not connect to this pin.	
16	PWUP	Apply a positive voltage (1.3 V $\leq$ VPWUP $\leq$ VPOS) to activate the device.	
	EXPOSED PAD	Exposed pad. The exposed pad is internally connected to GND and must be soldered to a low impedance ground plane.	

FIGURE 2. Terminal connections.

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## 4. VERIFICATION

4.1 <u>Product assurance requirements</u>. The manufacturer is responsible for performing all inspection and test requirements as indicated in their internal documentation. Such procedures should include proper handling of electrostatic sensitive devices, classification, packaging, and labeling of moisture sensitive devices, as applicable.

#### 5. PREPARATION FOR DELIVERY

5.1 <u>Packaging</u>. Preservation, packaging, labeling, and marking shall be in accordance with the manufacturer's standard commercial practices for electrostatic discharge sensitive devices.

#### 6. NOTES

6.1 ESDS. Devices are electrostatic discharge sensitive and are classified as ESDS class 1 minimum.

6.2 <u>Configuration control</u>. The data contained herein is based on the salient characteristics of the device manufacturer's data book. The device manufacturer reserves the right to make changes without notice. This drawing will be modified as changes are provided.

6.3 <u>Suggested source(s) of supply</u>. Identification of the suggested source(s) of supply herein is not to be construed as a guarantee of present or continued availability as a source of supply for the item. DLA Land and Maritime maintains an online database of all current sources of supply at <u>https://landandmaritimeapps.dla.mil/Programs/Smcr/</u>.

Vendor item drawing administrative control number <u>1</u> /	Device manufacturer CAGE code	Mode of transportation and quantity	Vendor part number
V62/16616-01XE	24355	Tube, 50 units	AD8351SCPZ-EP
V62/16616-01XE	24355	Reel, 1500 units	AD8351SCPZ-EP-R7

1/ The vendor item drawing establishes an administrative control number for identifying the item on the engineering documentation.

CAGE code

24355

Source of supply

Analog Devices Route 1 Industrial Park P.O. Box 9106 Norwood, MA 02062 Point of contact: Raheen Business Park Limerick, Ireland

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